

# SS52BGF~SS520BGF

## Surface Mount Schottky Barrier Rectifier

ROHS

### Features

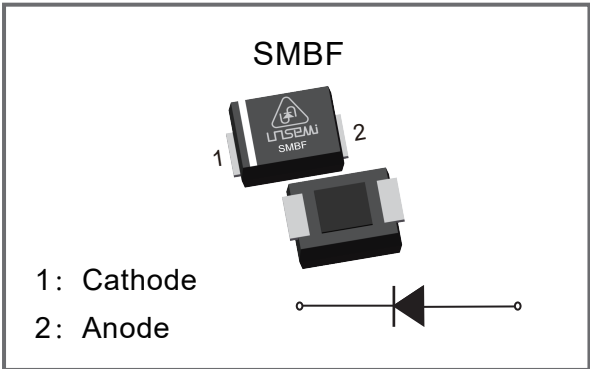
- ◆ Metal silicon junction, majority carrier conduction
- ◆ For surface mounted applications
- ◆ Low power loss, high efficiency
- ◆ High forward surge current capability
- ◆ For use in low voltage, high frequency inverters, free wheeling, and polarity protection applications

### Mechanical Data

- ◆ Case: SMBF
- ◆ Quantity Per Reel : 3,000pcs
- ◆ Approx. Weight : 57mg/0.002oz
- ◆ Terminals: Solderable per MIL-STD-750, Method 2026



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### Maximum Ratings and Electrical Characteristics

Ratings at 25°C ambient temperature unless otherwise specified.

Single phase half-wave 60Hz, resistive or inductive load, for capacitive load current derate by 20%.

Parameter		Symbol	SS52 BGF	SS54 BGF	SS56 BGF	SS58 BGF	SS510 BGF	SS512 BGF	SS515 BGF	SS520 BGF	Units
Maximum Repetitive Peak Reverse Voltage		VRRM	20	40	60	80	100	120	150	200	V
Maximum RMS Voltage		VRMS	14	28	42	56	70	84	105	140	V
Maximum DC Blocking Voltage		VDC	20	40	60	80	100	120	150	200	V
Maximum Average Forward Rectified Current		IF(AV)	5.0								A
Peak Forward Surge Current,8.3ms Single Half Sine-wave Superimposed on Rated Load (JEDEC method)		IFSM	120								A
Max Instantaneous Forward Voltage at 5A		VF	0.55		0.70		0.85				V
Maximum DC Reverse Current at Rated DC Reverse Voltage	Ta=25℃	IR	1.0								mA
	Ta=100℃	IR	50								
Typical Junction Capacitance <sup>(1)</sup>		Cj	800		500						pF
Typical Thermal Resistance <sup>(2)</sup>		RθJA	45								℃/W
Operating Junction Temperature Range		TJ	-55 ~ +150								℃
Storage Temperature Range		Tstg	-55 ~ +150								℃

Note:(1) Measured at 1 MHz and applied reverse voltage of 4VDC.

(2) P.C.B. mounted with 2.0" X 2.0" (5 X 5cm) copper pad areas.

### Electrical Characteristics Curves

Fig.1 Forward Current Derating Curve

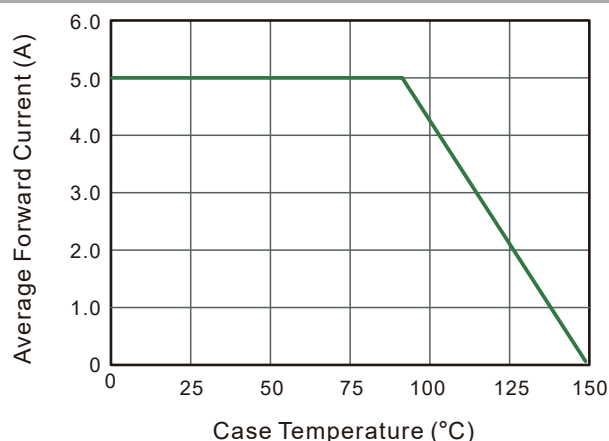


Fig. 2 Typical Reverse Characteristics

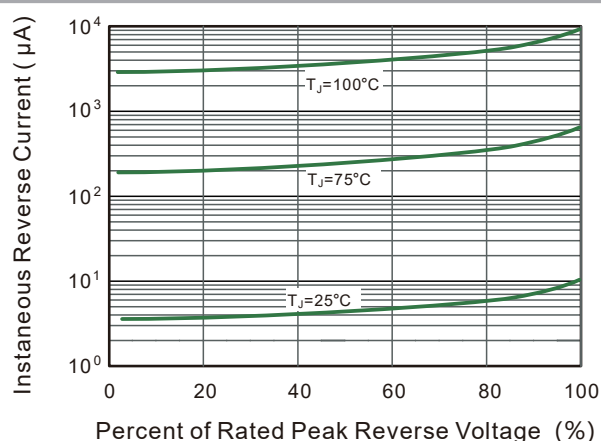


Fig.3 Typical Forward Characteristic

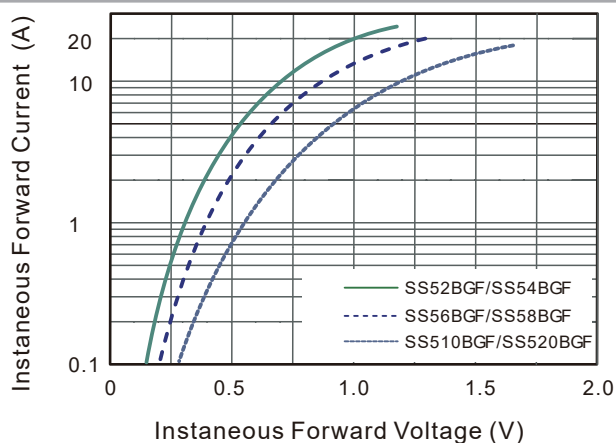


Fig. 4 Typical Junction Capacitance

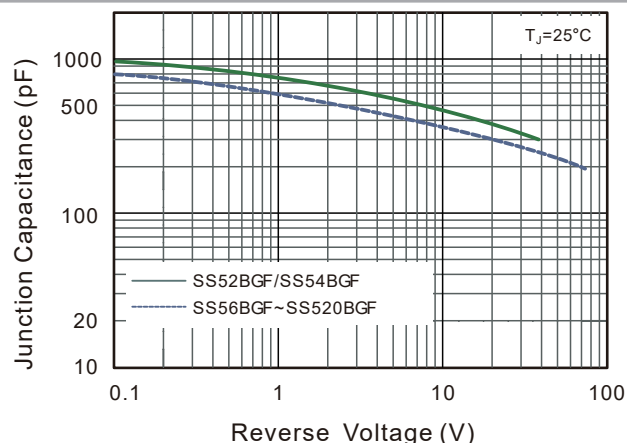


Fig.5 Maximum Non-Repetitive Peak Forward Surge Current

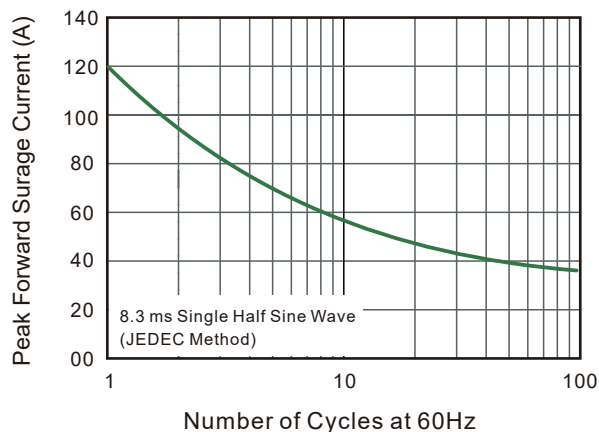
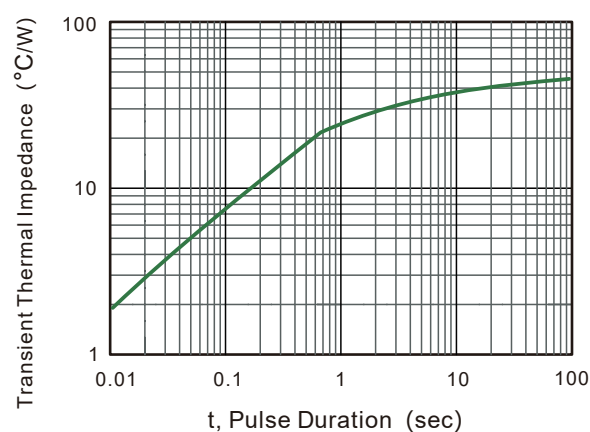
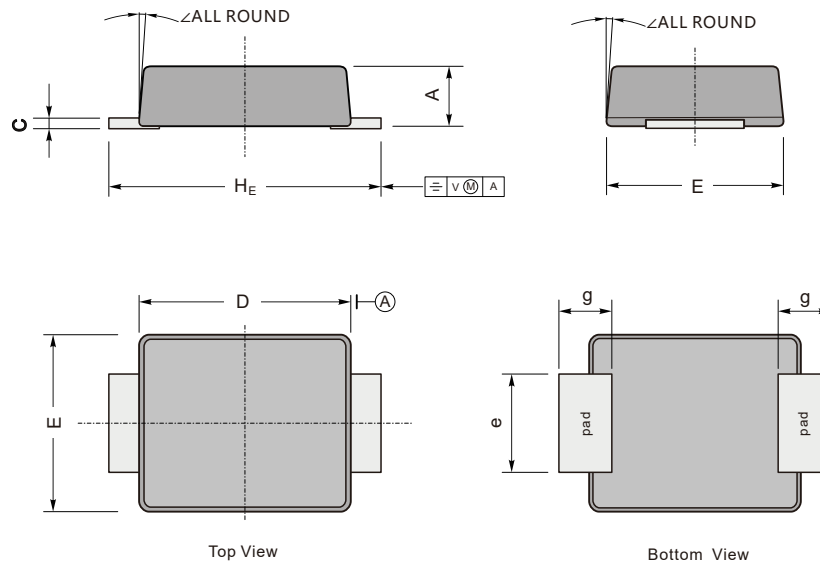


Fig. 6 Typical Transient Thermal Impedance



### Package Outline & Dimensions



UNIT		A	C	D	E	H <sub>E</sub>	e	g	∠
mm	max	1.3	0.26	4.4	3.7	5.5	2.2	1.0	9°
	min	1.1	0.18	4.2	3.5	5.1	1.9		
mil	max	51	10	173	146	216	86	40	
	min	43	7	165	138	200	75		

### Marking

Type Number	SS52BGF	SS54BGF	SS56BGF	SS58BGF	SS510BGF	SS512BGF	SS515BGF	SS520BGF
Making	S52B	S54B	S56B	S58B	S510B	S512B	S515B	S520B

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